www.vishay.com

Vishay Semiconductors

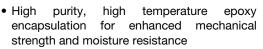
High Performance Schottky Rectifier, 2 x 8 A



PRIMARY CHARACTERISTICS								
I _{F(AV)}	2 x 8 A							
V_{R}	60 V, 80 V, 100 V							
V _F at I _F	0.58 V							
I _{RM} max.	7 mA at 125 °C							
T _J max.	175 °C							
E _{AS}	7.5 mJ							
Package	TO-220AB 3L							
Circuit configuration	Common cathode							

FEATURES

- 175 °C T_J operation
- Low forward voltage drop
- · High frequency operation





- Guard ring for enhanced ruggedness and long term reliability
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

This center tap Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL CHARACTERISTICS VALUES								
I _{F(AV)}	Rectangular waveform	16	Α					
V _{RRM}		60 to 100	V					
I _{FSM}	t _p = 5 μs sine	850	Α					
V _F	8 A _{pk} , T _J = 125 °C (per leg)	0.58	V					
TJ	Range	-55 to +175	°C					

VOLTAGE RATINGS								
PARAMETER SYMBOL VS-16CTQ060-M3 VS-16CTQ080-M3 VS-16CTQ100-M3 UNITS								
Maximum DC reverse voltage	V_{R}	60	80	100	V			
Maximum working peak reverse voltage	V_{RWM}	00	00	100	V			

ABSOLUTE MAXIMUM RATINGS								
PARAMETER		SYMBOL	TEST COND	VALUES	UNITS			
Maximum average forward	per leg		50 % duty avalo at T ₂ = 148 °	o at T = 149 °C rootangular wayafarm				
current, see fig. 5	per device	I _{F(AV)}	50 % duty cycle at T _C = 148 °C, rectangular waveform		16	Α		
Maximum peak one cycle no	Maximum peak one cycle non-repetitive		5 μs sine or 3 μs rect. pulse	Following any rated load condition and with	850	А		
surge current per leg, see fig. 7		I _{FSM}	10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	275			
Non-repetitive avalanche energy per leg		E _{AS}	T _J = 25 °C, I _{AS} = 0.50 A, L = 60 mH		7.50	mJ		
Repetitive avalanche current per leg		I _{AR}	Current decaying linearly to ze Frequency limited by T _J maxing		0.50	Α		



www.vishay.com

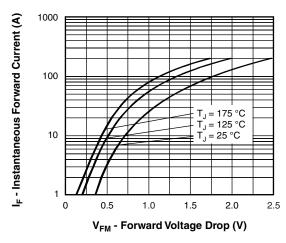
Vishay Semiconductors

ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS			
		8 A	T _{.1} = 25 °C	0.72			
Maximum forward voltage drop per leg	V (1)	16 A	1j=25 C	0.88	V		
See fig. 1	V _{FM} ⁽¹⁾	8 A	T 105 °C	0.58			
		16 A	T _J = 125 °C	0.69			
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	V _R = rated V _R	0.55	mA		
See fig. 2	'RM '''	T _J = 125 °C	$v_R = rate u v_R$	7.0			
Threshold voltage	V _{F(TO)}	T T manimum		0.415	٧		
Forward slope resistance	r _t	$T_J = T_J$ maximum		11.07	mΩ		
Maximum junction capacitance per leg	C _T	V _R = 5 V _{DC} (test signal range	500	pF			
Typical series inductance per leg	L _S	Measured lead to lead 5 m	8.0	nH			
Maximum voltage rate of change	dV/dt	Rated V _R	10 000	V/µs			

Note

 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range	T _J , T _{Stg}		-55 to 175	°C				
Maximum thermal resistance, junction to case per leg	R _{thJC}	DC operation	3.25	°C/W				
Maximum thermal resistance junction to case per package	R _{thJC}	DC operation	1.63					
Typical thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth and greased	0.50					
Approximate weight			2	g				
Approximate weight			0.07	OZ.				
Mauratian tannus	ım		6 (5)	kgf · cm				
Mounting torque maximu	ım		12 (10)	(lbf · in)				
			16CTQ060					
Marking device		Case style TO-220AB 3L	16CT	Q080				
			16CT	16CTQ100				



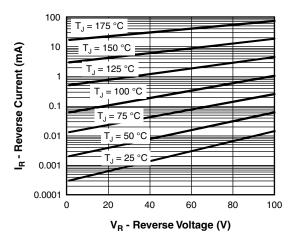


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

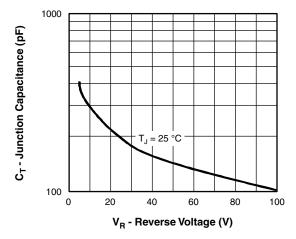


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

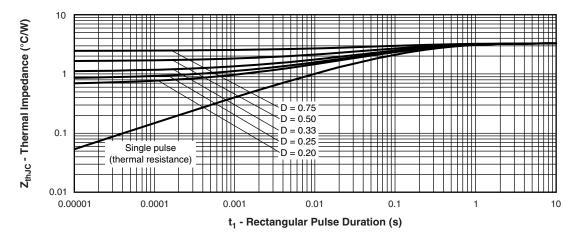


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

www.vishay.com

Vishay Semiconductors

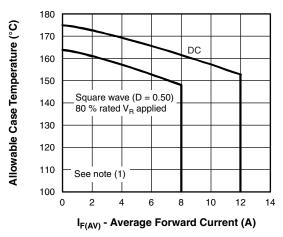


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

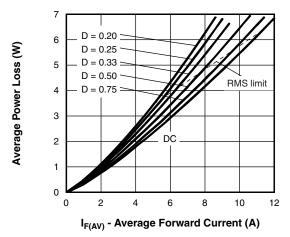


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

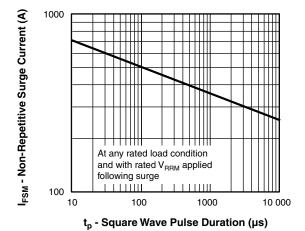


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

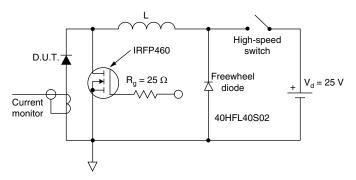


Fig. 8 - Unclamped Inductive Test Circuit

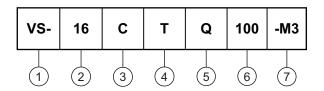
Note

Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{th,JC}$; $Pd = forward power loss = I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = inverse power loss = V_{R1} \times I_{R} (1 - D)$; I_R at $V_{R1} = 80 \%$ rated V_R applied

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (16 = 16 A)

Circuit configuration

C = common cathode

4 - Package

T = TO-220

5 - Schottky "Q" series

060 = 60 V 080 = 80 V

6

Voltage rating

100 = 100 V

7 - Environmental digit

-M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)									
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION							
VS-16CTQ060-M3	50	Antistatic plastic tubes							
VS-16CTQ080-M3	50	Antistatic plastic tubes							
VS-16CTQ100-M3	50	Antistatic plastic tubes							

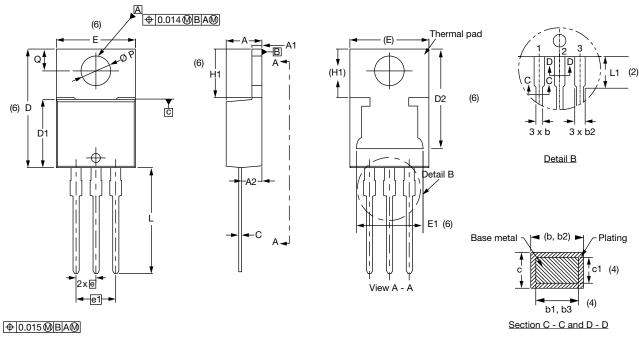
LINKS TO RELATED DOCUMENTS						
Dimensions	www.vishay.com/doc?96154					
Part marking information	www.vishay.com/doc?95028					
SPICE model	www.vishay.com/doc?95279					



Vishay Semiconductors

TO-220AB 3L

DIMENSIONS in millimeters and inches



Lead tip \	
	1

Conforms to JEDEC® outline TO-220AB

SYMBOL	MILLIMETERS		INC	HES	NOTES	NOTES		NOTES	NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	STMBOL	MIN.		MAX.	MIN.	MAX.	NOTES			
Α	4.25	4.65	0.167	0.183			D2	11.68	13.30	0.460	0.524	6, 7			
A1	1.14	1.40	0.045	0.055			E	10.11	10.51	0.398	0.414	3, 6			
A2	2.50	2.92	0.098	0.115			E1	6.86	8.89	0.270	0.350	6			
b	0.69	1.01	0.027	0.040			е	2.41	2.67	0.095	0.105				
b1	0.38	0.97	0.015	0.038	4		e1	4.88	5.28	0.192	0.208				
b2	1.20	1.73	0.047	0.068			H1	6.09	6.48	0.240	0.255	6			
b3	1.14	1.73	0.045	0.068	4		L	13.52	14.02	0.532	0.552				
С	0.36	0.61	0.014	0.024			L1	3.32	3.82	0.131	0.150	2			
с1	0.36	0.56	0.014	0.022	4		ØΡ	3.54	3.91	0.139	0.154				
D	14.85	15.35	0.585	0.604	3		Q	2.60	3.00	0.102	0.118				
D1	8.38	9.02	0.330	0.355											

Notes

- $^{(1)}$ Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3, and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- (7) Outline conforms to JEDEC® TO-220, except D2



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.